

Dual Enhancement Mode MOSFET (N-and P-Channel)

Features

- N Channel**

30V/8.7A,

$R_{DS(ON)} = 21m\Omega$ (max.) @ $V_{GS} = 10V$

$R_{DS(ON)} = 30m\Omega$ (max.) @ $V_{GS} = 4.5V$

- P Channel**

-30V/-8.2A,

$R_{DS(ON)} = 24m\Omega$ (max.) @ $V_{GS} = -10V$

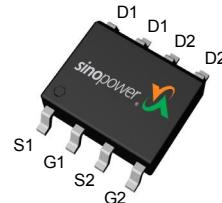
$R_{DS(ON)} = 38m\Omega$ (max.) @ $V_{GS} = -4.5V$

- 100% UIS Tested

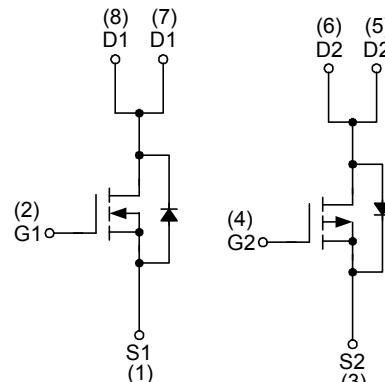
- Reliable and Rugged

- Lead Free Available (RoHS Compliant)

Pin Description



Top View of SOP – 8



N-Channel MOSFET

P-Channel MOSFET

Applications

- Synchronous Rectification.
- Motor Control
- High Current, High Speed Switching

Ordering and Marking Information

| | |
|---|--|
| SM4603CS  Assembly Material | Package Code K : SOP-8 Operating Junction Temperature Range C : -55 to 175 °C Handling Code TR : Tape & Reel (2500ea/reel) Assembly Material G : Halogen and Lead Free Device |
| SM4603CS K :  XXXXX - Date Code | |

Note : SINOPOWER lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. SINOPOWER lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. SINOPOWER defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

SINOPOWER reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | N Channel | P Channel | Unit | | | |
|-----------------------|--|---|------------------------|------------------|--------------------|---|--|
| Common Ratings | | | | | | | |
| V_{DSS} | Drain-Source Voltage | 30 | -30 | V | | | |
| V_{GSS} | Gate-Source Voltage | ± 20 | ± 20 | V | | | |
| T_J | Maximum Junction Temperature | 175 | | $^\circ\text{C}$ | | | |
| T_{STG} | Storage Temperature Range | -55 to 175 | | $^\circ\text{C}$ | | | |
| I_S | Diode Continuous Forward Current | 2 | -2 | A | | | |
| I_{DP} | 300 μs Pulse Drain Current Tested | $V_{GS}=10\text{V(N)}, V_{GS}=-10\text{V(P)}$ | 32 | -32 | A | | |
| I_D | Continuous Drain Current | | $T_A=25^\circ\text{C}$ | 8.7 | -8.2 | A | |
| | | | $T_A=70^\circ\text{C}$ | 7.3 | -6.8 | | |
| P_D | Maximum Power Dissipation | | $T_A=25^\circ\text{C}$ | 2.4 | 2.4 | W | |
| | | | $T_A=70^\circ\text{C}$ | 1.7 | 1.7 | | |
| $R_{\theta JL}$ | Thermal Resistance-Junction to Lead | Steady State | 50 | 50 | $^\circ\text{C/W}$ | | |
| $R_{\theta JA}$ | Thermal Resistance-Junction to Ambient | $t \leq 10\text{s}$ | 62.5 | 62.5 | $^\circ\text{C/W}$ | | |
| | | Steady State | 110 | 110 | | | |
| I_{AS}^a | Avalanche Current, Single pulse ($L=0.5\text{mH}$) | 7.2 | | A | | | |
| E_{AS}^a | Avalanche Energy, Single pulse ($L=0.5\text{mH}$) | 12 | | mJ | | | |

Note a : UIS tested and pulse width limited by maximum junction temperature 150°C (initial temperature $T_j=25^\circ\text{C}$).

N Channel Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Test Conditions | N Channel | | | Unit |
|---|----------------------------------|---|-----------|------|-----------|------------------|
| | | | Min. | Typ. | Max. | |
| Static Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}, I_{\text{DS}}=250\mu\text{A}$ | 30 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{\text{DS}}=24\text{V}, V_{\text{GS}}=0\text{V}$ | - | - | 1 | μA |
| | | $T_J=85^\circ\text{C}$ | - | - | 30 | |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=250\mu\text{A}$ | 1.5 | 1.8 | 2.5 | V |
| I_{GSS} | Gate Leakage Current | $V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$ | - | - | ± 100 | nA |
| $R_{\text{DS(ON)}}^{\text{b}}$ | Drain-Source On-state Resistance | $V_{\text{GS}}=10\text{V}, I_{\text{DS}}=8\text{A}$ | - | 17 | 21 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=4.5\text{V}, I_{\text{DS}}=5\text{A}$ | - | 23 | 30 | |
| Diode Characteristics | | | | | | |
| V_{SD}^{b} | Diode Forward Voltage | $I_{\text{SD}}=1\text{A}, V_{\text{GS}}=0\text{V}$ | - | 0.75 | 1.1 | V |
| t_{rr} | Reverse Recovery Time | $I_{\text{DS}}=8\text{A}, dI_{\text{SD}}/dt=100\text{A}/\mu\text{s}$ | - | 12 | - | ns |
| Q_{rr} | Reverse Recovery Charge | | - | 3.5 | - | nC |
| Dynamic Characteristics ^c | | | | | | |
| R_{G} | Gate Resistance | $V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, F=1\text{MHz}$ | - | 1.5 | - | Ω |
| C_{iss} | Input Capacitance | $V_{\text{GS}}=0\text{V}, V_{\text{DS}}=15\text{V}, \text{Frequency}=1.0\text{MHz}$ | - | 410 | - | pF |
| C_{oss} | Output Capacitance | | - | 70 | - | |
| C_{rss} | Reverse Transfer Capacitance | | - | 40 | - | |
| $t_{\text{d(ON)}}$ | Turn-on Delay Time | | - | 5.2 | - | |
| t_{r} | Turn-on Rise Time | $V_{\text{DD}}=15\text{V}, R_{\text{L}}=15\Omega, I_{\text{DS}}=1\text{A}, V_{\text{GEN}}=10\text{V}, R_{\text{G}}=6\Omega$ | - | 8.6 | - | ns |
| $t_{\text{d(OFF)}}$ | Turn-off Delay Time | | - | 13.5 | - | |
| t_{f} | Turn-off Fall Time | | - | 3.4 | - | |
| Gate Charge Characteristics ^c | | | | | | |
| Q_{g} | Total Gate Charge | $V_{\text{DS}}=15\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{DS}}=8\text{A}$ | - | 8.1 | 13 | nC |
| Q_{g} | Total Gate Charge | $V_{\text{DS}}=15\text{V}, V_{\text{GS}}=4.5\text{V}, I_{\text{DS}}=8\text{A}$ | - | 3.9 | 5.5 | |
| Q_{gth} | Threshold Gate Charge | | - | 0.73 | - | |
| Q_{gs} | Gate-Source Charge | | - | 1.5 | - | |
| Q_{gd} | Gate-Drain Charge | | - | 1.6 | - | |

Note b : Pulse test ; pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.

c : Guaranteed by design, not subject to production testing.

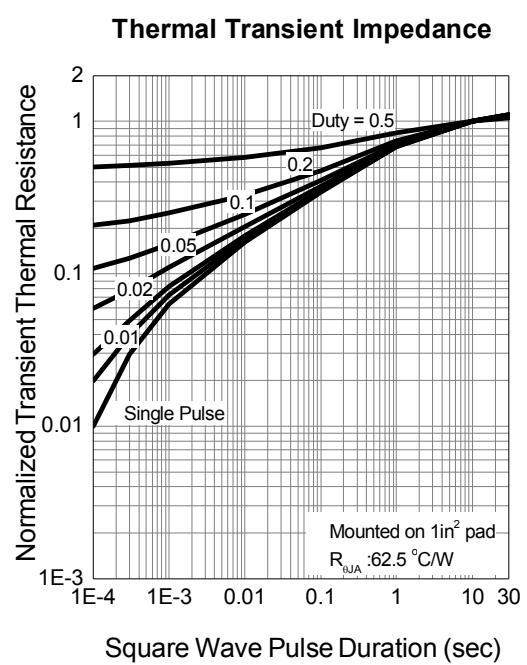
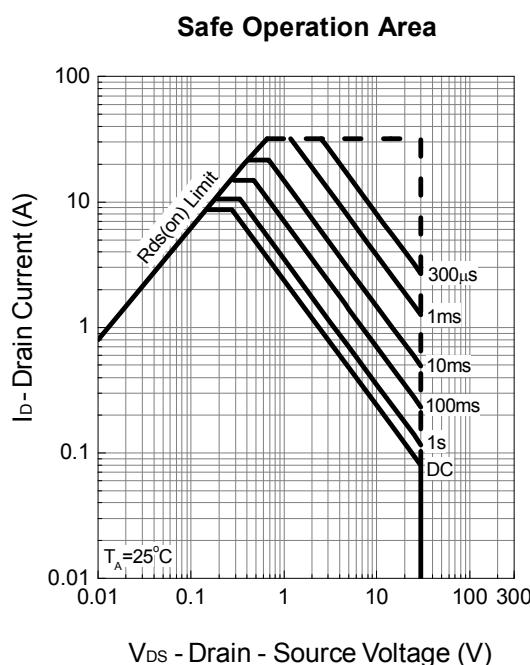
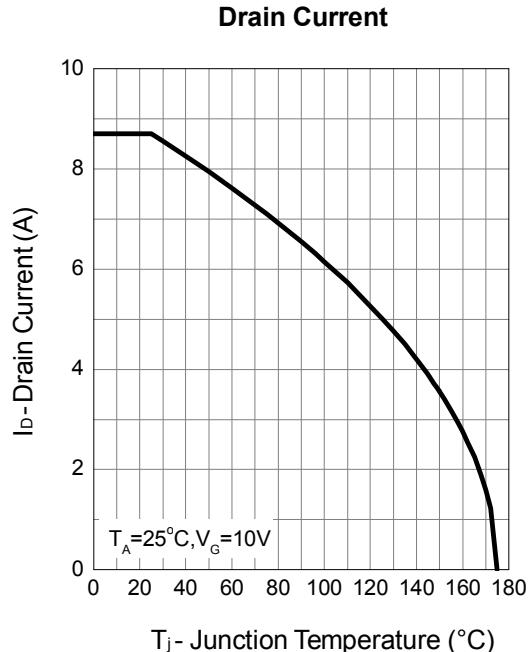
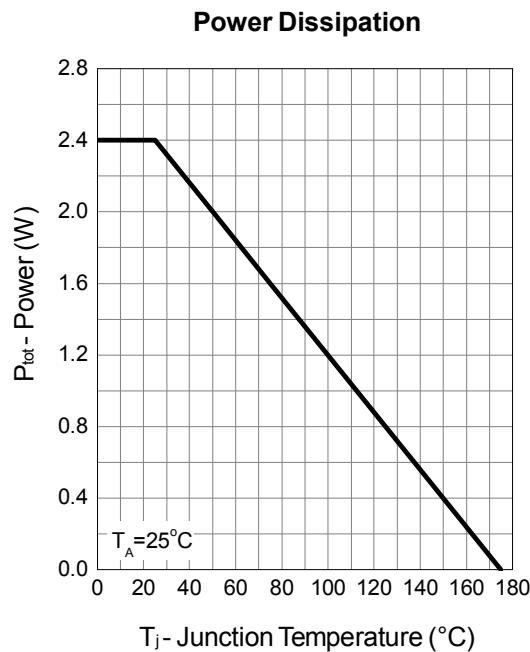
P Channel Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Test Conditions | P Channel | | | Unit |
|---|----------------------------------|--|-----------|-------|----------|------------------|
| | | | Min. | Typ. | Max. | |
| Static Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}, I_{\text{DS}}=-250\mu\text{A}$ | -30 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{\text{DS}}=-24\text{V}, V_{\text{GS}}=0\text{V}$ $T_J=85^\circ\text{C}$ | - | - | -1 | μA |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=-250\mu\text{A}$ | -1.3 | -1.8 | -2.3 | V |
| I_{GSS} | Gate Leakage Current | $V_{\text{GS}}=\pm20\text{V}, V_{\text{DS}}=0\text{V}$ | - | - | ±100 | nA |
| $R_{\text{DS(ON)}}^{\text{b}}$ | Drain-Source On-state Resistance | $V_{\text{GS}}=-10\text{V}, I_{\text{DS}}=-7.5\text{A}$ | - | 20 | 24 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=-4.5\text{V}, I_{\text{DS}}=-4\text{A}$ | - | 30 | 38 | |
| Diode Characteristics | | | | | | |
| V_{SD}^{b} | Diode Forward Voltage | $I_{\text{SD}}=-1\text{A}, V_{\text{GS}}=0\text{V}$ | - | -0.75 | -1 | V |
| t_{rr} | Reverse Recovery Time | $I_{\text{DS}}=-7.5\text{A},$ $dI_{\text{SD}}/dt=100\text{A}/\mu\text{s}$ | - | 18 | - | ns |
| Q_{rr} | Reverse Recovery Charge | | - | 9 | - | nC |
| Dynamic Characteristics ^c | | | | | | |
| R_{G} | Gate Resistance | $V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, F=1\text{MHz}$ | - | 7 | - | Ω |
| C_{iss} | Input Capacitance | $V_{\text{GS}}=0\text{V},$ $V_{\text{DS}}=-15\text{V},$ Frequency=1.0MHz | - | 840 | - | pF |
| C_{oss} | Output Capacitance | | - | 150 | - | |
| C_{rss} | Reverse Transfer Capacitance | | - | 110 | - | |
| $t_{\text{d(ON)}}$ | Turn-on Delay Time | $V_{\text{DD}}=-15\text{V}, R_{\text{L}}=15\Omega,$ $I_{\text{DS}}=-1\text{A}, V_{\text{GEN}}=-10\text{V},$ $R_{\text{G}}=6\Omega$ | - | 7.5 | - | ns |
| t_{r} | Turn-on Rise Time | | - | 8 | - | |
| $t_{\text{d(OFF)}}$ | Turn-off Delay Time | | - | 37 | - | |
| t_{f} | Turn-off Fall Time | | - | 16 | - | |
| Gate Charge Characteristics ^c | | | | | | |
| Q_{g} | Total Gate Charge | $V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=-10\text{V},$ $I_{\text{DS}}=-7.5\text{A}$ | - | 18 | - | nC |
| Q_{g} | Total Gate Charge | $V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=-4.5\text{V},$ $I_{\text{DS}}=-7.5\text{A}$ | - | 8.5 | - | |
| Q_{gth} | Threshold Gate Charge | | - | 1.6 | - | |
| Q_{gs} | Gate-Source Charge | | - | 3 | - | |
| Q_{gd} | Gate-Drain Charge | | - | 4 | - | |

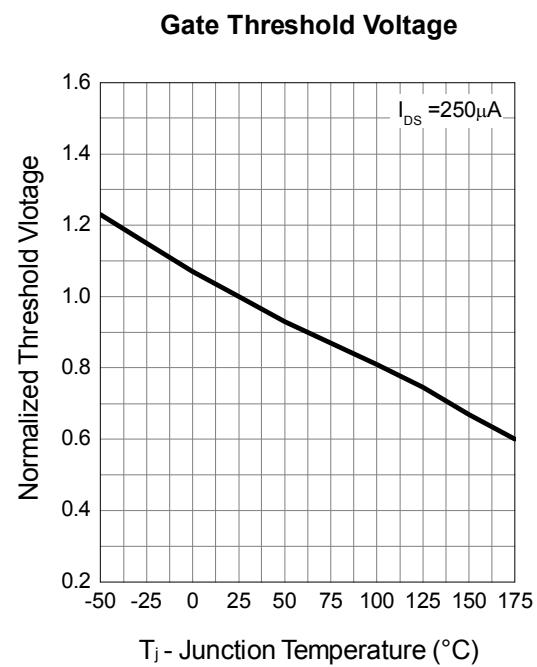
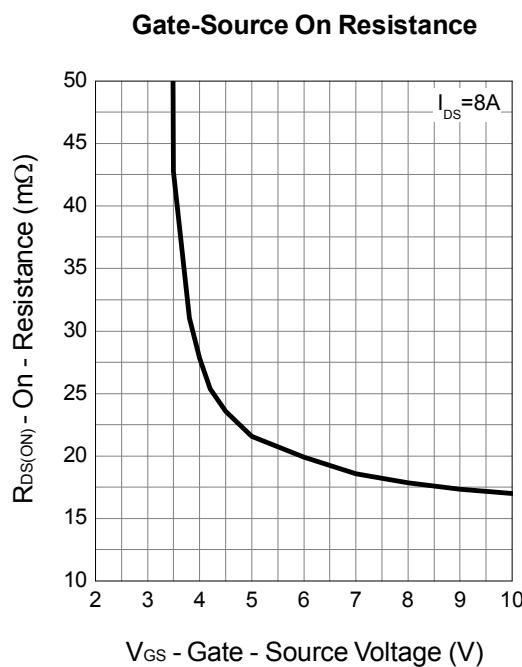
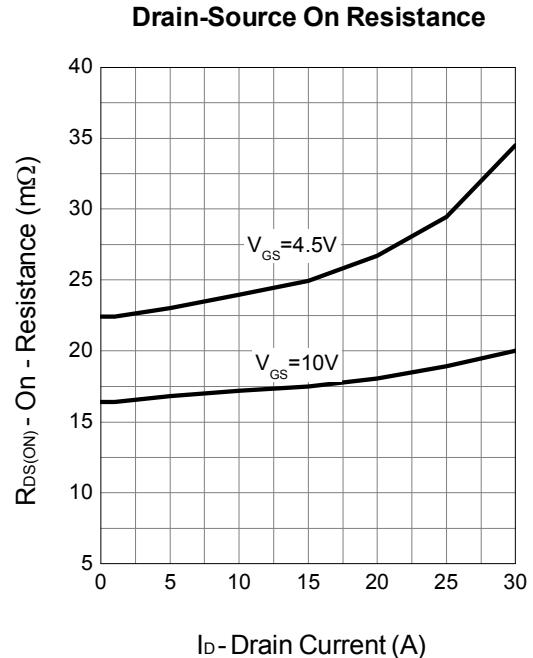
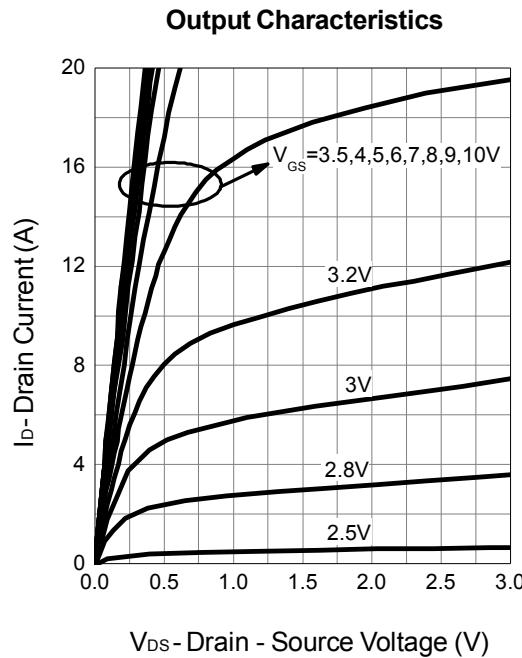
Note b : Pulse test; pulse width $\leq300\mu\text{s}$, duty cycle $\leq2\%$.

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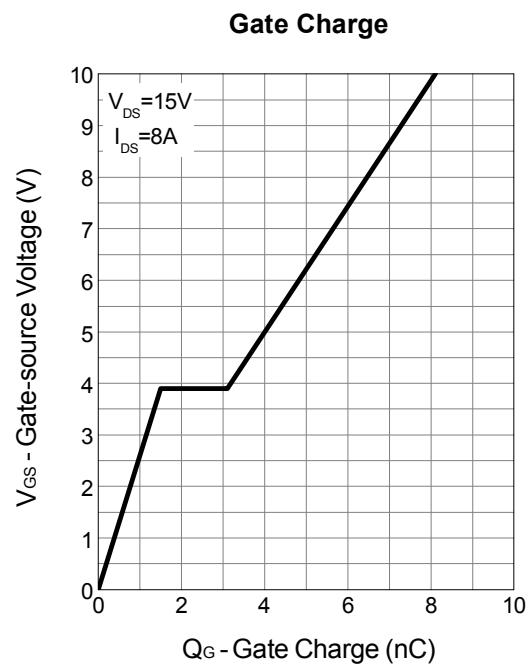
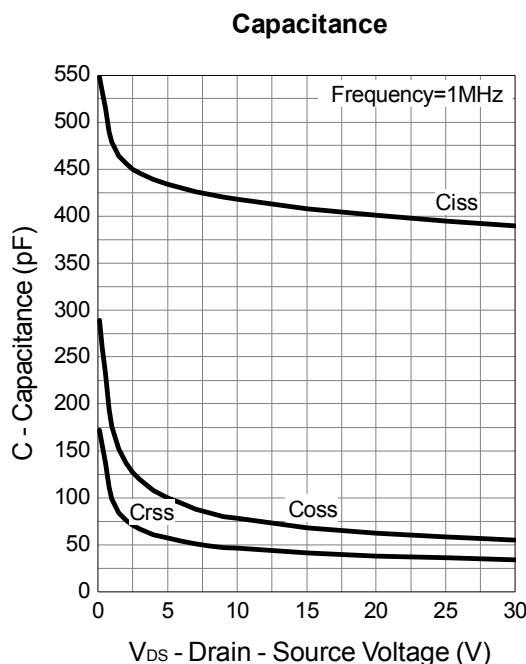
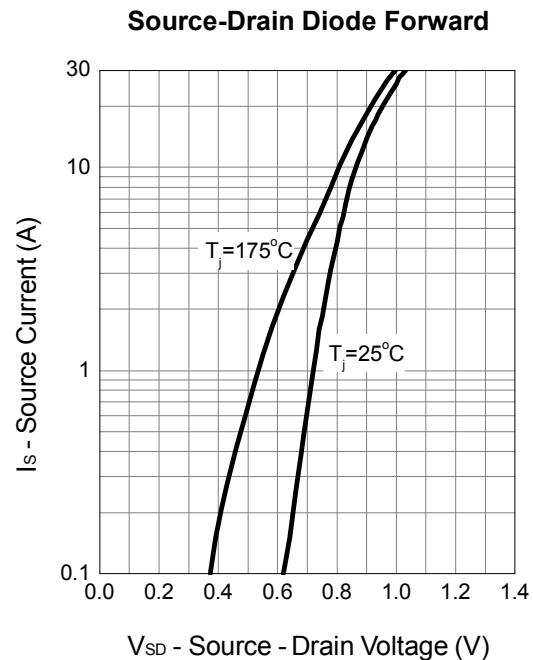
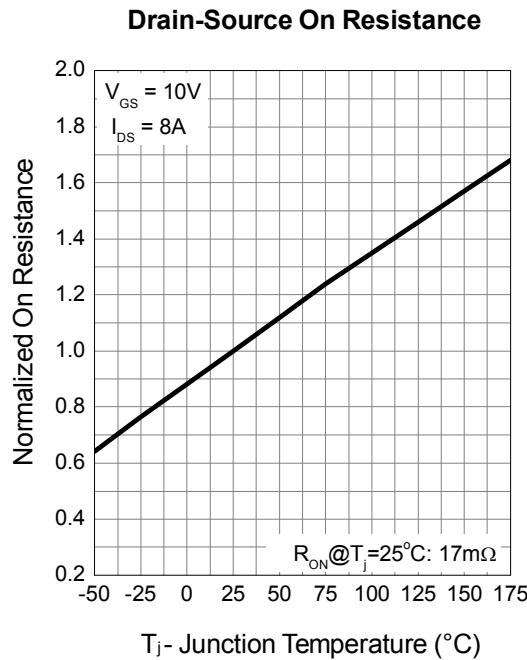
N Channel Typical Operating Characteristics



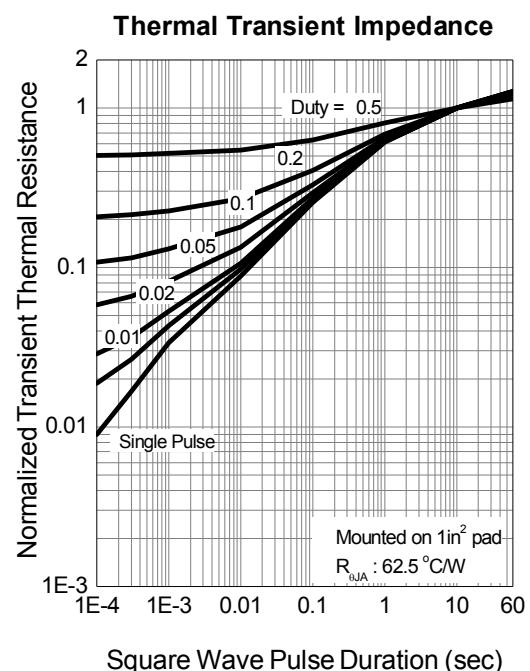
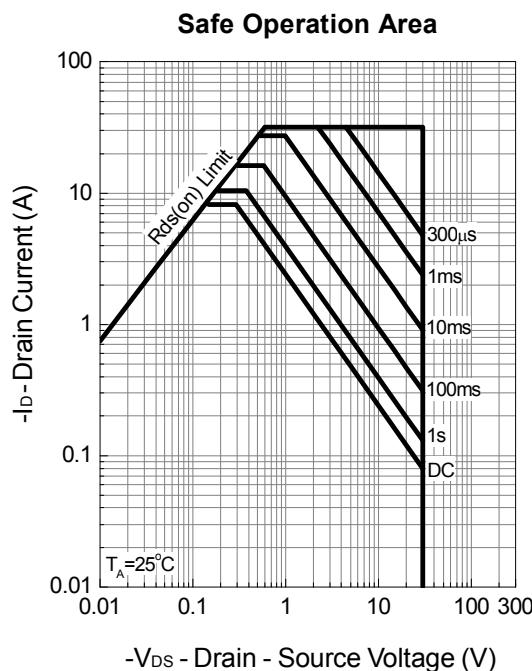
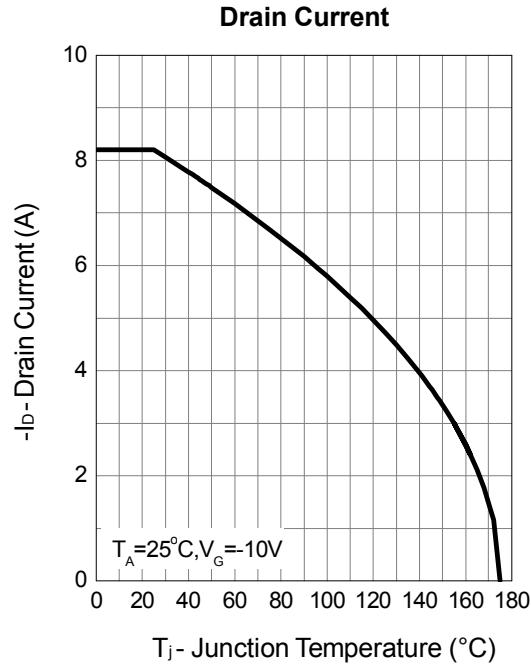
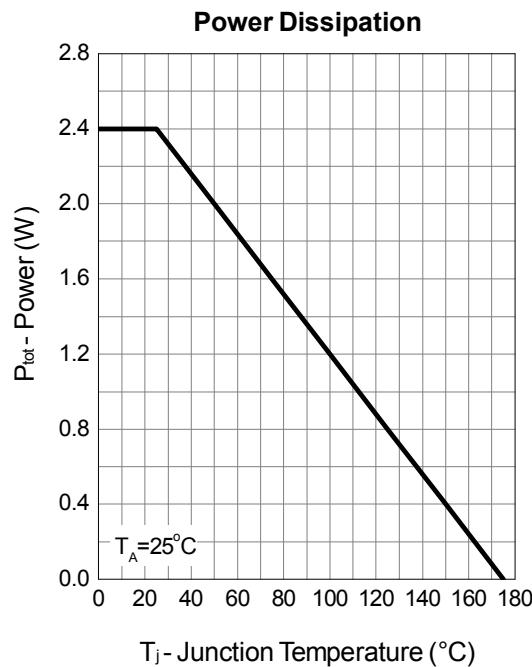
N Channel Typical Operating Characteristics (Cont.)



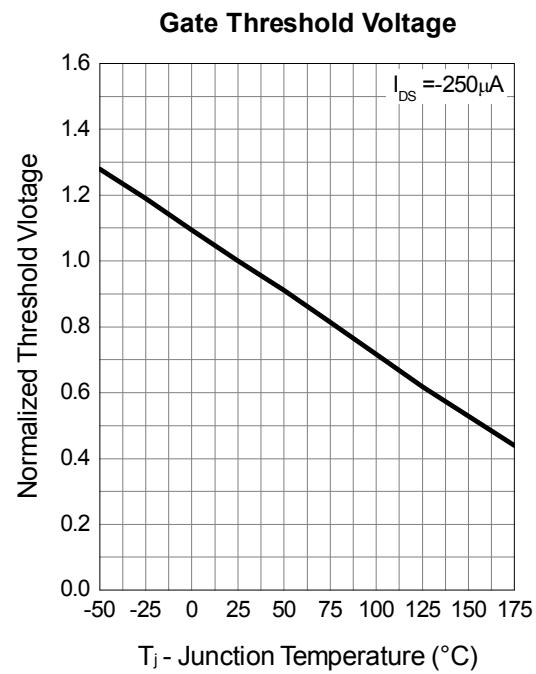
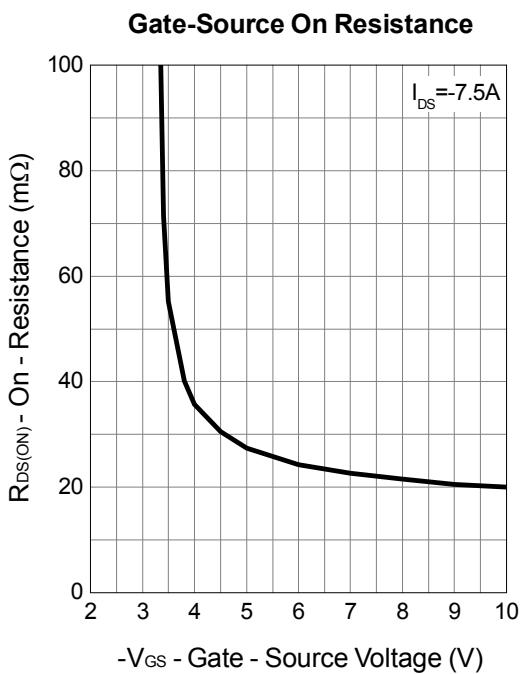
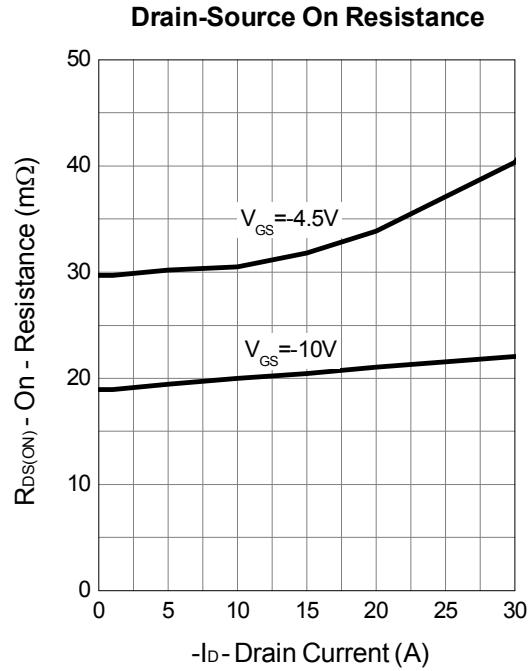
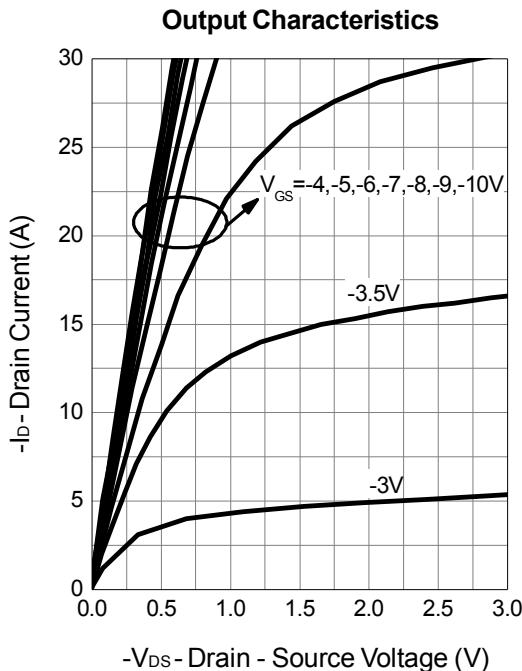
N Channel Typical Operating Characteristics (Cont.)



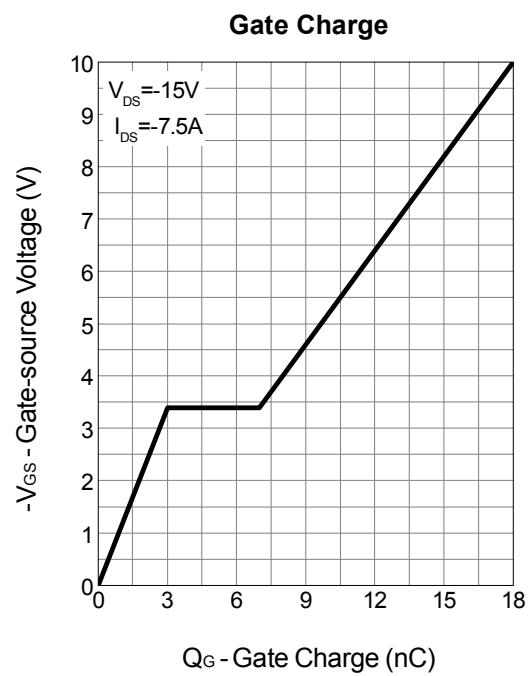
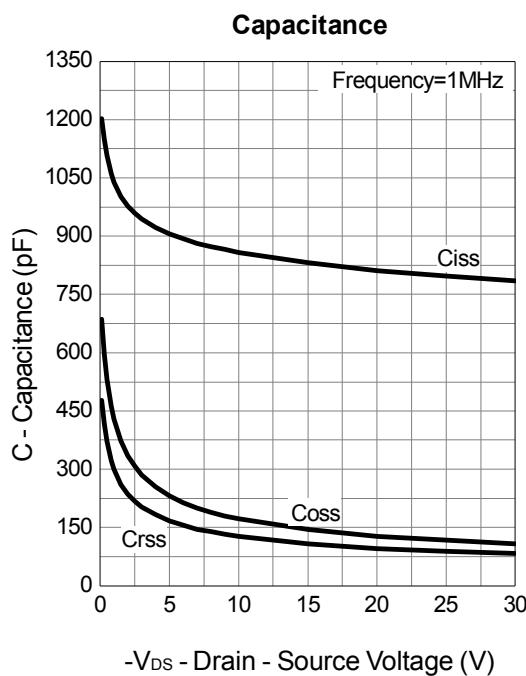
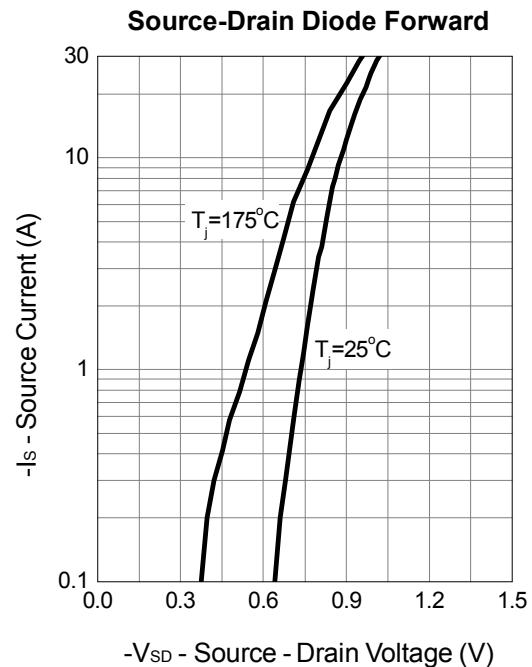
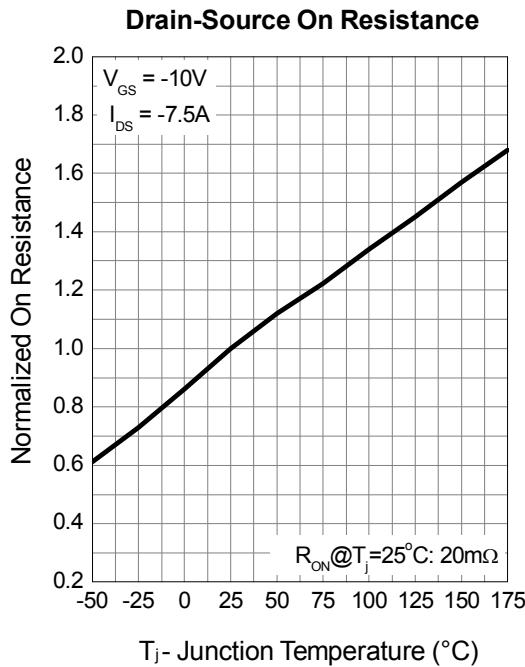
P Channel Typical Operating Characteristics



P Channel Typical Operating Characteristics (Cont.)

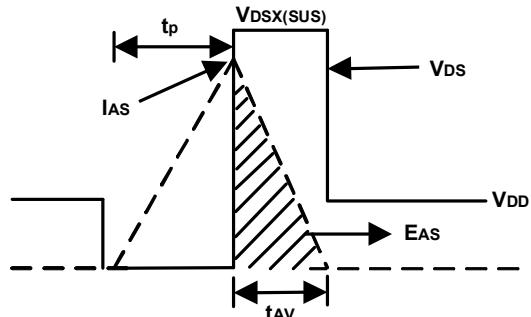
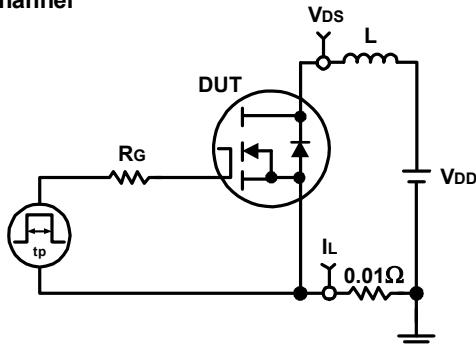


P Channel Typical Operating Characteristics (Cont.)

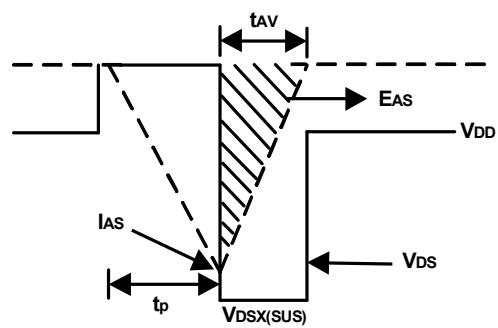
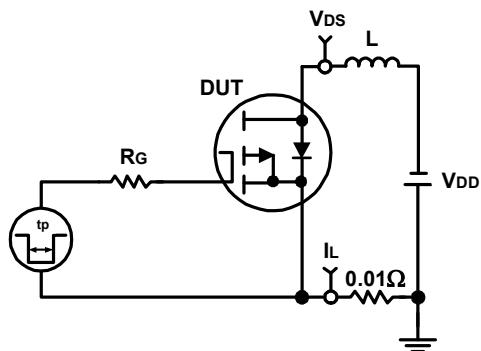


Avalanche Test Circuit and Waveforms

N Channel

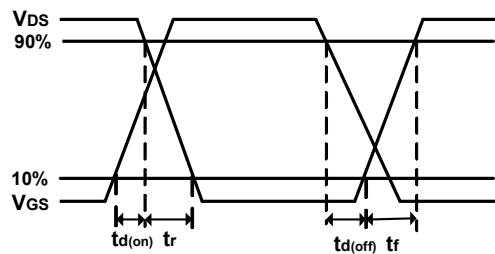
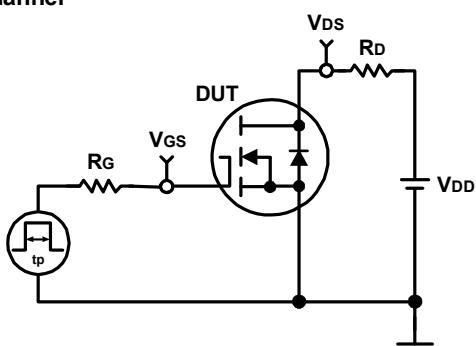


P Channel

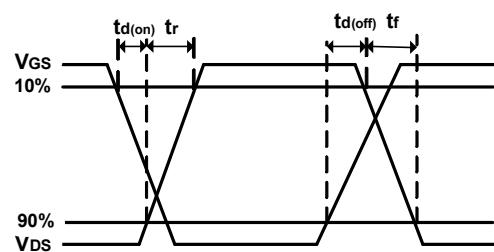
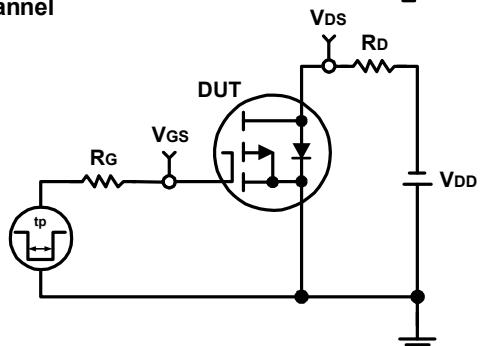


Switching Time Test Circuit and Waveforms

N Channel

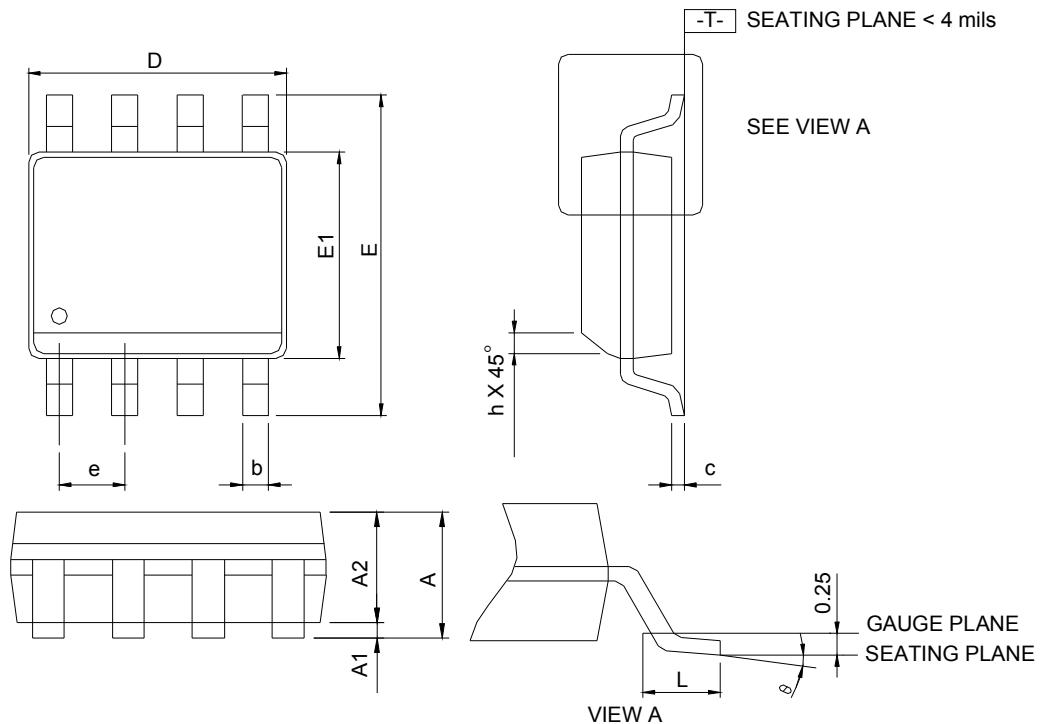


P Channel



Package Information

SOP-8

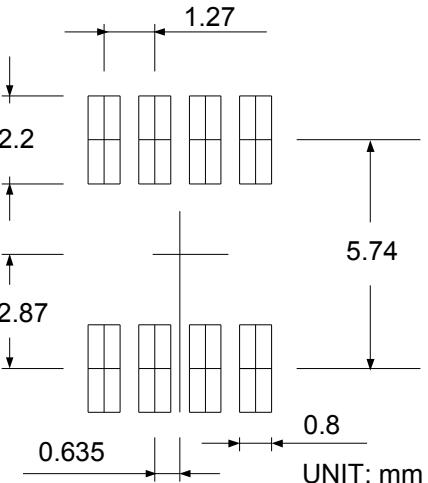


| SYMBOL | SOP-8 | | | |
|--------|-------------|------|-----------|-------|
| | MILLIMETERS | | INCHES | |
| | MIN. | MAX. | MIN. | MAX. |
| A | - | 1.75 | - | 0.069 |
| A1 | 0.10 | 0.25 | 0.004 | 0.010 |
| A2 | 1.25 | - | 0.049 | - |
| b | 0.31 | 0.51 | 0.012 | 0.020 |
| c | 0.17 | 0.25 | 0.007 | 0.010 |
| D | 4.80 | 5.00 | 0.189 | 0.197 |
| E | 5.80 | 6.20 | 0.228 | 0.244 |
| E1 | 3.80 | 4.00 | 0.150 | 0.157 |
| e | 1.27 BSC | | 0.050 BSC | |
| h | 0.25 | 0.50 | 0.010 | 0.020 |
| L | 0.40 | 1.27 | 0.016 | 0.050 |
| θ | 0° | 8° | 0° | 8° |

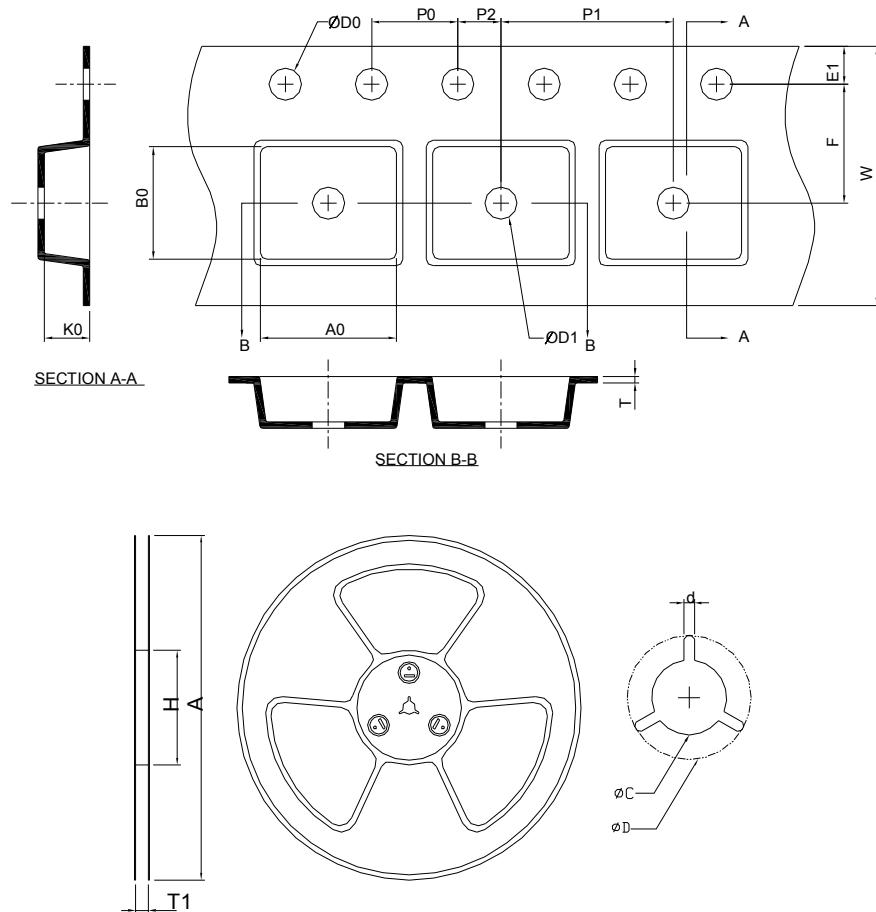
Note: 1. Follow JEDEC MS-012 AA.

2. Dimension "D" does not include mold flash, protrusions or gate burrs.
Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
3. Dimension "E" does not include inter-lead flash or protrusions.
Inter-lead flash and protrusions shall not exceed 10 mil per side.

RECOMMENDED LAND PATTERN



Carrier Tape & Reel Dimensions

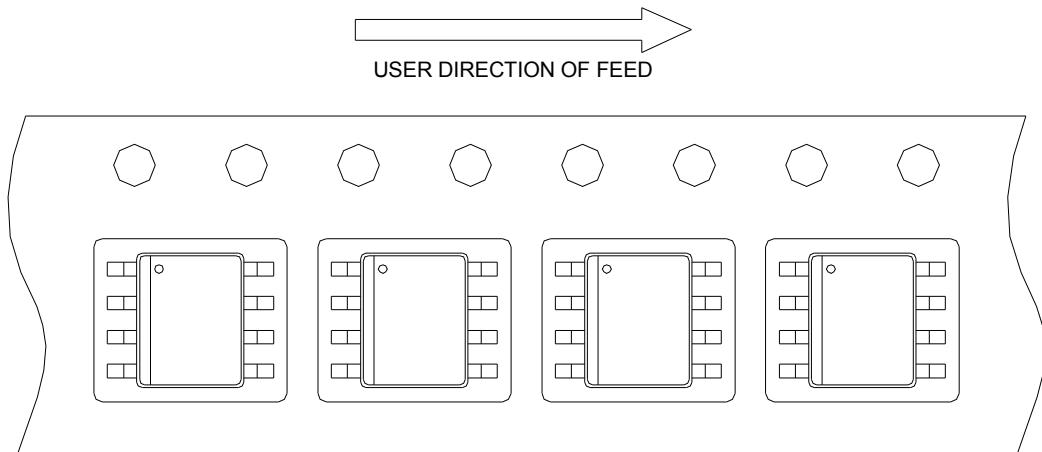


| Application | A | H | T1 | C | d | D | W | E1 | F |
|-------------|------------------|----------------|----------------------|----------------------|----------|---------------------|-----------------|-----------------|-----------------|
| SOP-8 | 330.0 ± 2.00 | 50 MIN. | $12.4 + 2.00 - 0.00$ | $13.0 + 0.50 - 0.20$ | 1.5 MIN. | 20.2 MIN. | 12.0 ± 0.30 | 1.75 ± 0.10 | 5.5 ± 0.05 |
| | P0 | P1 | P2 | D0 | D1 | T | A0 | B0 | K0 |
| | 4.0 ± 0.10 | 8.0 ± 0.10 | 2.0 ± 0.05 | $1.5 + 0.10 - 0.00$ | 1.5 MIN. | $0.6 + 0.00 - 0.40$ | 6.40 ± 0.20 | 5.20 ± 0.20 | 2.10 ± 0.20 |

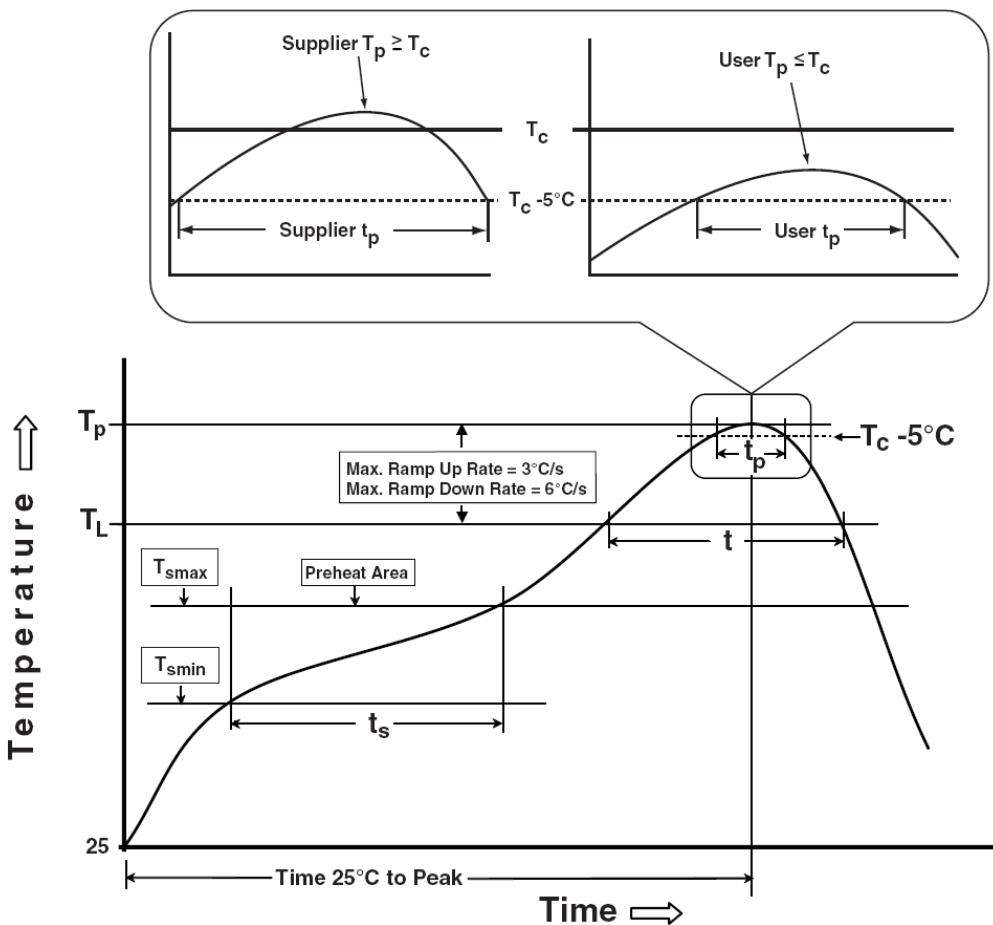
(mm)

Taping Direction Information

SOP-8



Classification Profile



Classification Reflow Profiles

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|---|------------------------------------|------------------------------------|
| Preheat & Soak | | |
| Temperature min (T_{smin}) | 100 °C | 150 °C |
| Temperature max (T_{smax}) | 150 °C | 200 °C |
| Time (T_{smin} to T_{smax}) (t_s) | 60-120 seconds | 60-120 seconds |
| Average ramp-up rate (T_{smax} to T_p) | 3 °C/second max. | 3°C/second max. |
| Liquidous temperature (T_L) Time at liquidous (t_L) | 183 °C 60-150 seconds | 217 °C 60-150 seconds |
| Peak package body Temperature (T_p)* | See Classification Temp in table 1 | See Classification Temp in table 2 |
| Time (t_p)** within 5°C of the specified classification temperature (T_c) | 20** seconds | 30** seconds |
| Average ramp-down rate (T_p to T_{smax}) | 6 °C/second max. | 6 °C/second max. |
| Time 25°C to peak temperature | 6 minutes max. | 8 minutes max. |

* Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum.
 ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

Table 1. SnPb Eutectic Process – Classification Temperatures (T_c)

| Package Thickness | Volume mm ³ <350 | Volume mm ³ ≥350 |
|-------------------|--------------------------------|--------------------------------|
| <2.5 mm | 235 °C | 220 °C |
| ≥2.5 mm | 220 °C | 220 °C |

Table 2. Pb-free Process – Classification Temperatures (T_c)

| Package Thickness | Volume mm ³ <350 | Volume mm ³ 350-2000 | Volume mm ³ >2000 |
|-------------------|--------------------------------|------------------------------------|---------------------------------|
| <1.6 mm | 260 °C | 260 °C | 260 °C |
| 1.6 mm – 2.5 mm | 260 °C | 250 °C | 245 °C |
| ≥2.5 mm | 250 °C | 245 °C | 245 °C |

Reliability Test Program

| Test item | Method | Description |
|---------------|---------------|--|
| SOLDERABILITY | JESD-22, B102 | 5 Sec, 245°C |
| HTRB | JESD-22, A108 | 1000 Hrs, 80% of VDS max @ T_{jmax} |
| HTGB | JESD-22, A108 | 1000 Hrs, 100% of VGS max @ T_{jmax} |
| PCT | JESD-22, A102 | 168 Hrs, 100%RH, 2atm, 121°C |
| TCT | JESD-22, A104 | 500 Cycles, -65°C~150°C |

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